

ESD PROTECTION DIODE

STAND-OFF VOLTAGE – 3.3 Volts POWER DISSIPATION - 350 Watts

GENERAL DESCRIPTION

Ultra low capacitance bidirectional ElectroStatic Discharge (ESD)protection diodes in small Surface-Mounted Device (SMD) plastic packages designed to protect one data line from the damage caused by ESD.

FEATURES

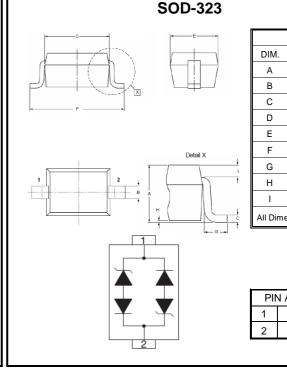
- Protects one power or I/O line
- Max. peak pulse power : Ppp = 350W at tp = 8/20 us
- Ultra Low Capacitance : 0.7pF Typical
- Low clamping voltage
- IEC 61000-4-2, level 4 (ESD), > ±30KV (air) ; > ±27KV (contact)
- Qualified to AEC-Q101 Rev_C

APPLICATION

- Ethernet 10/100/1000 Base T
- Handheld Wireless Systems
- USB Interface

MECHANICAL DATA

- Case material: "Green" molding compound UL flammability classification 94V-0 (No Br, Sb, Cl)
- Terminals: Lead Free Plating (Matte Tin Finish), solderable per J-STD-002 and JESD22-B/02.
- Moisture Sensitivity: Leve 1 per J-STD-020C
- Component in accordance to RoHs 2011/65/EU



SOD-323			
DIM.	MIN.	MAX.	
Α	0.80	1.10	
В	0.25	0.40	
С	0.10	0.25	
D	1.60	1.80	
Е	1.15	1.35	
F	2.30	2.70	
G	0.15	0.45	
Н		0.1	
ı	0.15	0.25	
All Dimensions in millimeter			

PIN ASSIGNMENT		
1	Cathode	
2	Cathode	

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

ABSOLUTE RATINGS

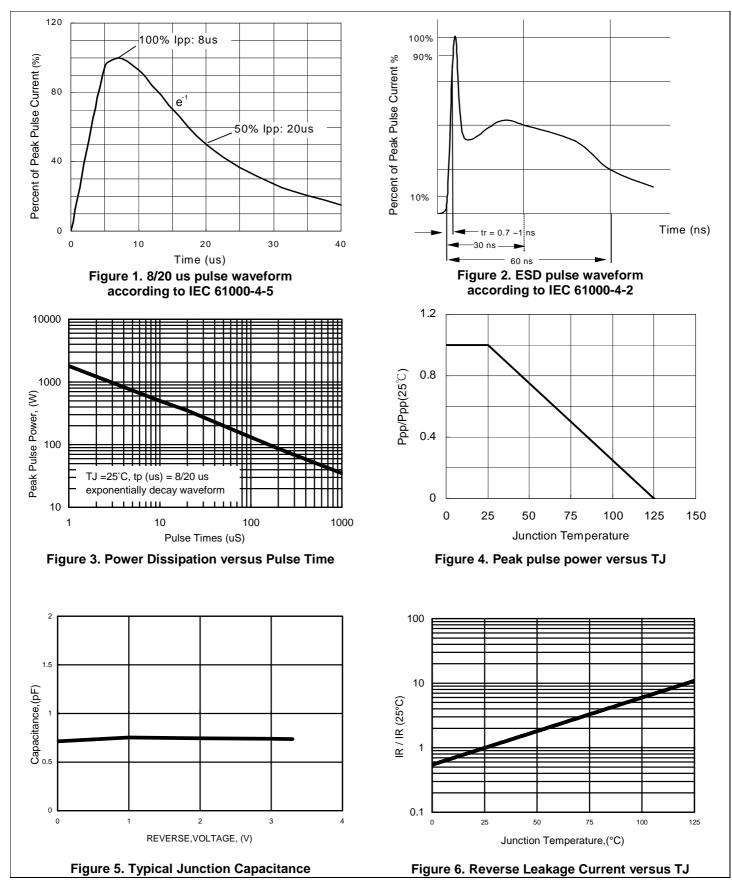
PARAMETER	SYMBOL	VALUE	UNIT
Peak pulse power (8/20us waveform)	P _{PP}	350	W
Peak pulse current (8/20us waveform)	I _{PP}	19	Α
Operating junction temperature range	TJ	-55 to +125	°C
Storage temperature range	T _{STG}	-55 to +150	°C
Soldering temperature, t max = 10s	T _L	260	°C

ELECTRICAL CHARACTERISTICS

PARAMETER TEST CONDITIONS		SYMBOL	MIN.	TYP.	MAX	UNIT
Reverse standoff voltage		V_{DRM}			3.3	V
Breakdown voltage	I t = 1mA	V_{BR}	4			V
Reverse leakage current	V _{DRM} = 3.3V	I _{RM}			4.5	uA
Junction capacitance	$V_R = 0V, f = 1MHz,$	C _J		0.7	0.8	pF
Clamping voltage	I _{PP} = 1A (8/20 us)	V _C			7	V
	I _{PP} = 19A (8/20 us)	v c			18.5	v
				REV.	1, Feb2017, K	SIR85

RATING AND CHARACTERISTIC CURVES L35L3V3CB2





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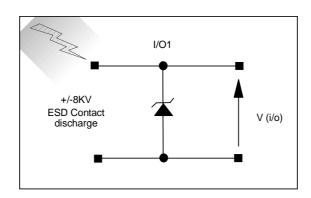
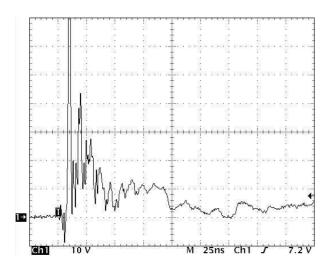


Figure 7. ESD Test Configuration





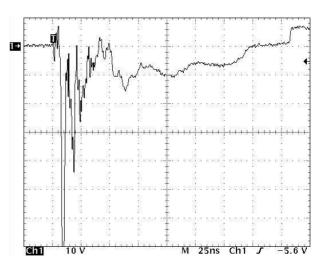
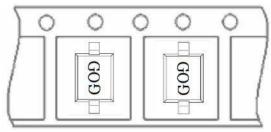


Figure 9. Clamped -8 kV ESD voltage waveform

MARKING AND PACKAGING INFORMATION L35L3V3CB2



Marking and Orientation:

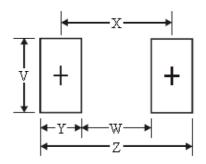


Note: Marking is none direction

Packaging Information:

DEVICE	Q'TY/REEL	REEL DIA.	Q'TY/BOX	Q'TY/CARTON
	(PCS)	(INCH)	(PCS)	(PCS)
L35L3V3CB2	3000	7	45K	90K

SOD-323 Soldering Pad Layout:



Dim.	Millimeters	Inches
Z	3.05	0.120
X	2.15	0.084
W	1.25	0.049
Y	0.90	0.035
V	0.70	0.027



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